



US00D953302S

(12) **United States Design Patent**  
**Zhang et al.**

(10) **Patent No.:** **US D953,302 S**  
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(54) **WIRELESS EARPHONE**

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*Primary Examiner* — Paula Allen Greene

(57) **CLAIM**

The ornamental design for a wireless earphone, as shown and described.

(\*\*) Term: **15 Years**

**DESCRIPTION**

(21) Appl. No.: **29/746,820**

(22) Filed: **Aug. 18, 2020**

(51) **LOC (13) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/223**

(58) **Field of Classification Search**  
USPC ..... D14/223, 205; D24/174; 128/864–866;  
381/380, 381, 322, 328; 455/90.3, 575.1,  
455/569.1  
CPC ..... H04R 1/10; H04R 25/00; H04R 25/02;  
H04R 1/1066; H04R 1/1016; H04R  
5/033; H04R 5/0335; H04R 1/1083;  
H04R 1/1091; H04R 1/1058

See application file for complete search history.

FIG. 1 is a first perspective view of the first embodiment of a wireless earphone showing my new design;  
FIG. 2 is a second perspective view of the first embodiment thereof;  
FIG. 3 is a front view of the first, embodiment thereof;  
FIG. 4 is a back view of the first embodiment thereof;  
FIG. 5 is a left side view of the first embodiment thereof;  
FIG. 6 is a right side view of the first embodiment thereof;  
FIG. 7 is a top view of the first embodiment thereof;  
FIG. 8 is a bottom view of the first embodiment thereof;  
FIG. 9 is a first perspective view of the second embodiment of a wireless earphone showing my new design;  
FIG. 10 is a second perspective view of the second embodiment thereof;  
FIG. 11 is a front view of the second embodiment thereof;  
FIG. 12 is a back view of the second embodiment thereof;  
FIG. 13 is a left side view of the second embodiment thereof;  
FIG. 14 is a right side view of the second embodiment thereof;  
FIG. 15 is a top view of the second embodiment thereof;  
and,  
FIG. 16 is a bottom view of the second embodiment thereof.  
The broken lines shown in the drawings depict portions of the wireless earphone in which the design is embodied that form no part of the claimed design.

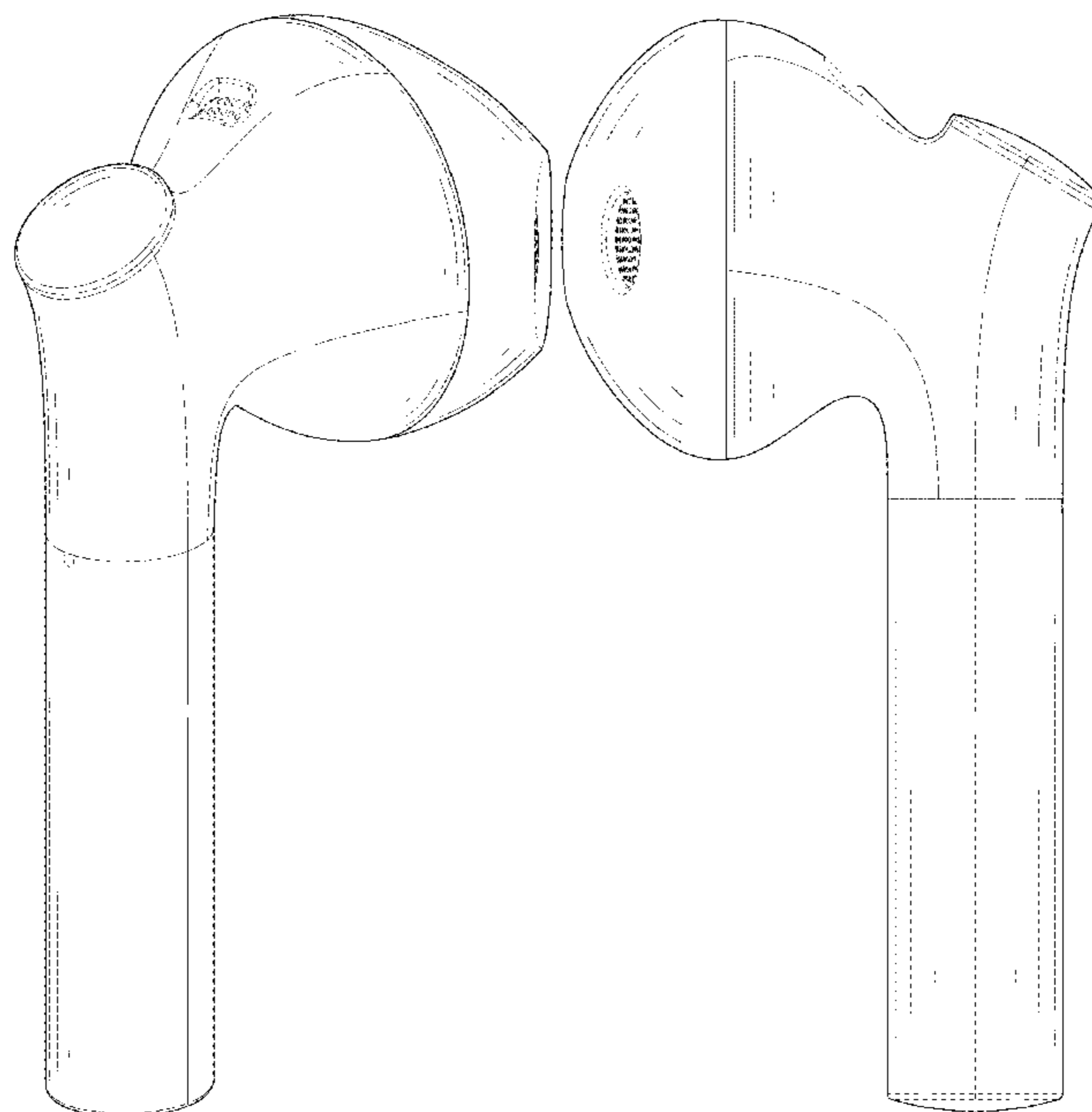
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**1 Claim, 16 Drawing Sheets**



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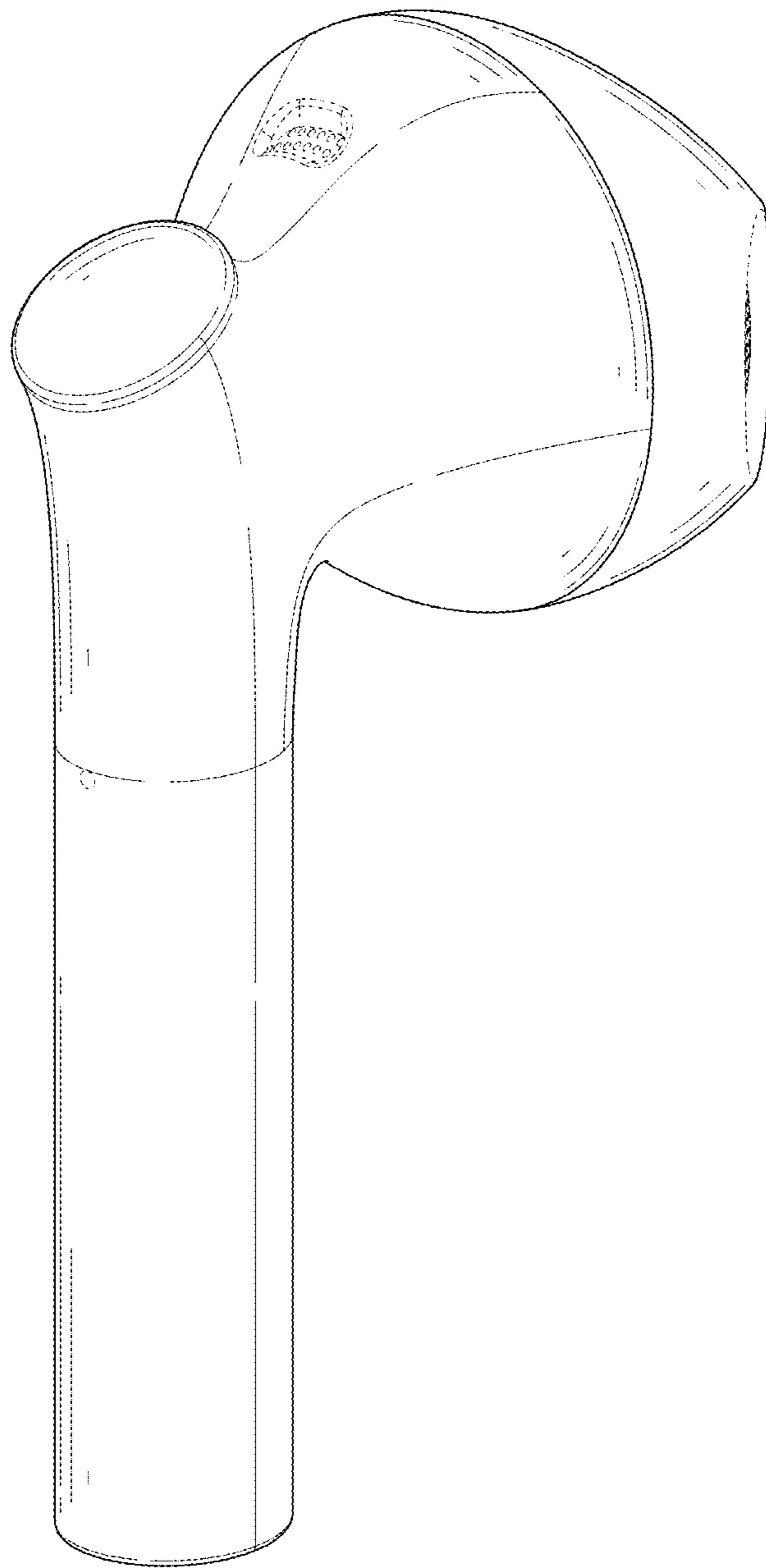


FIG. 1

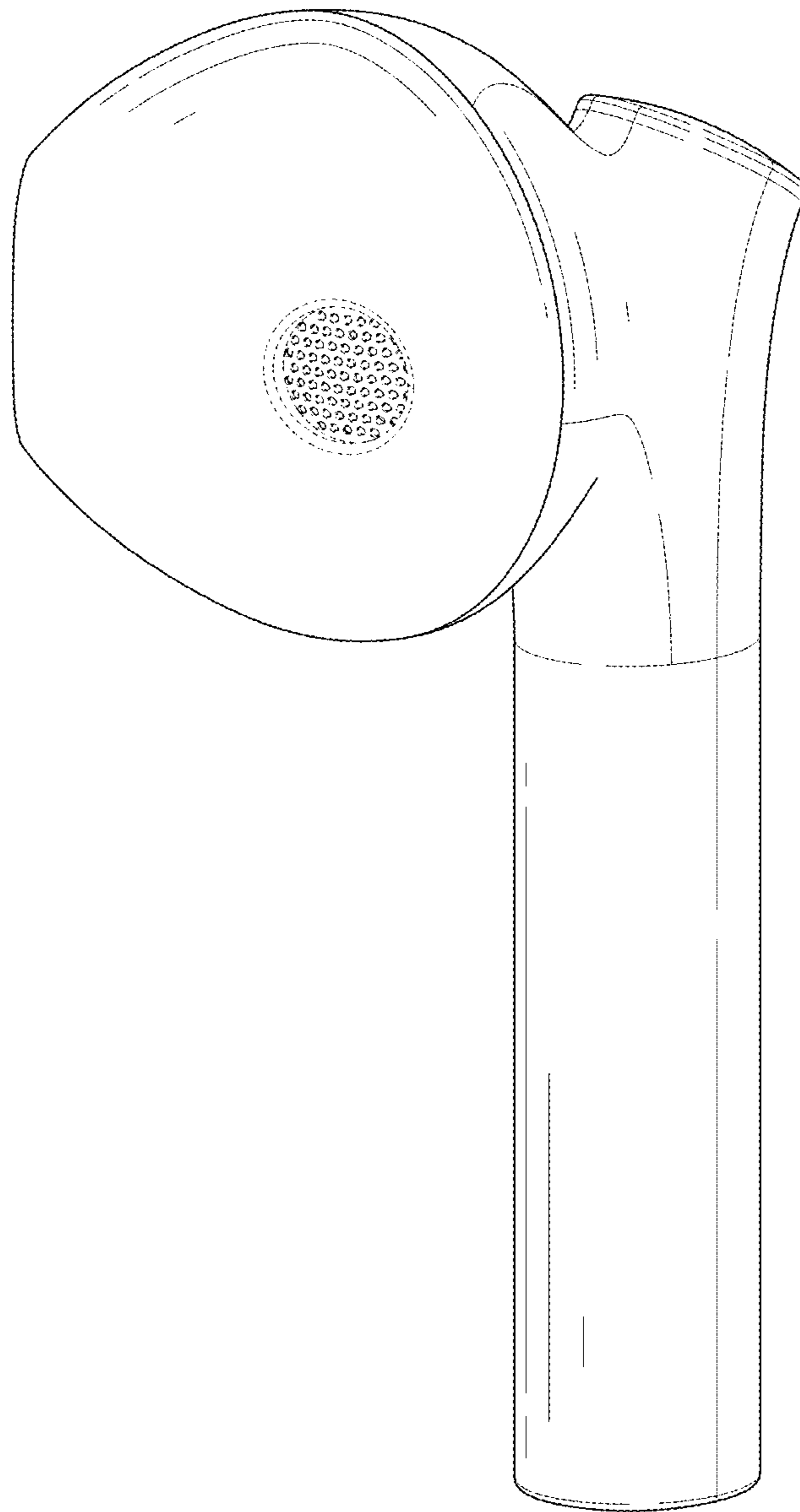


FIG. 2

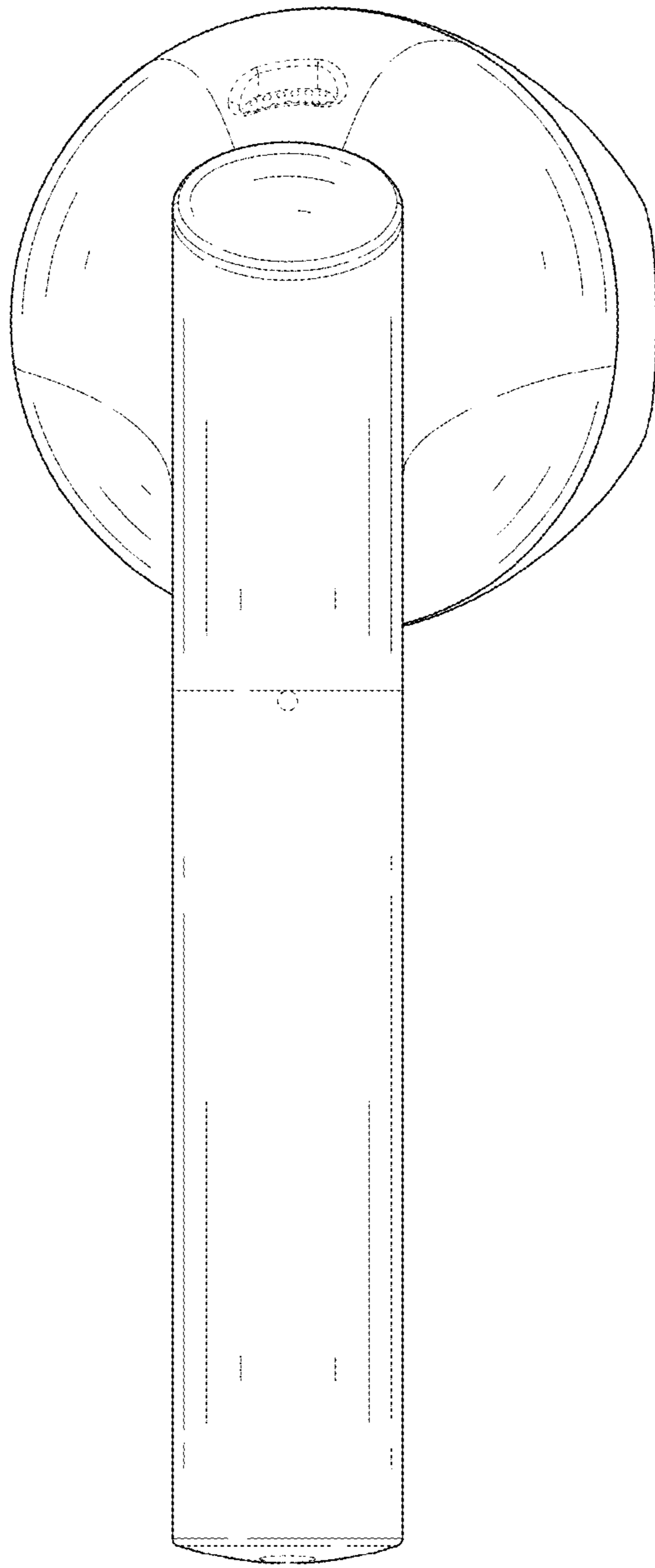


FIG. 3

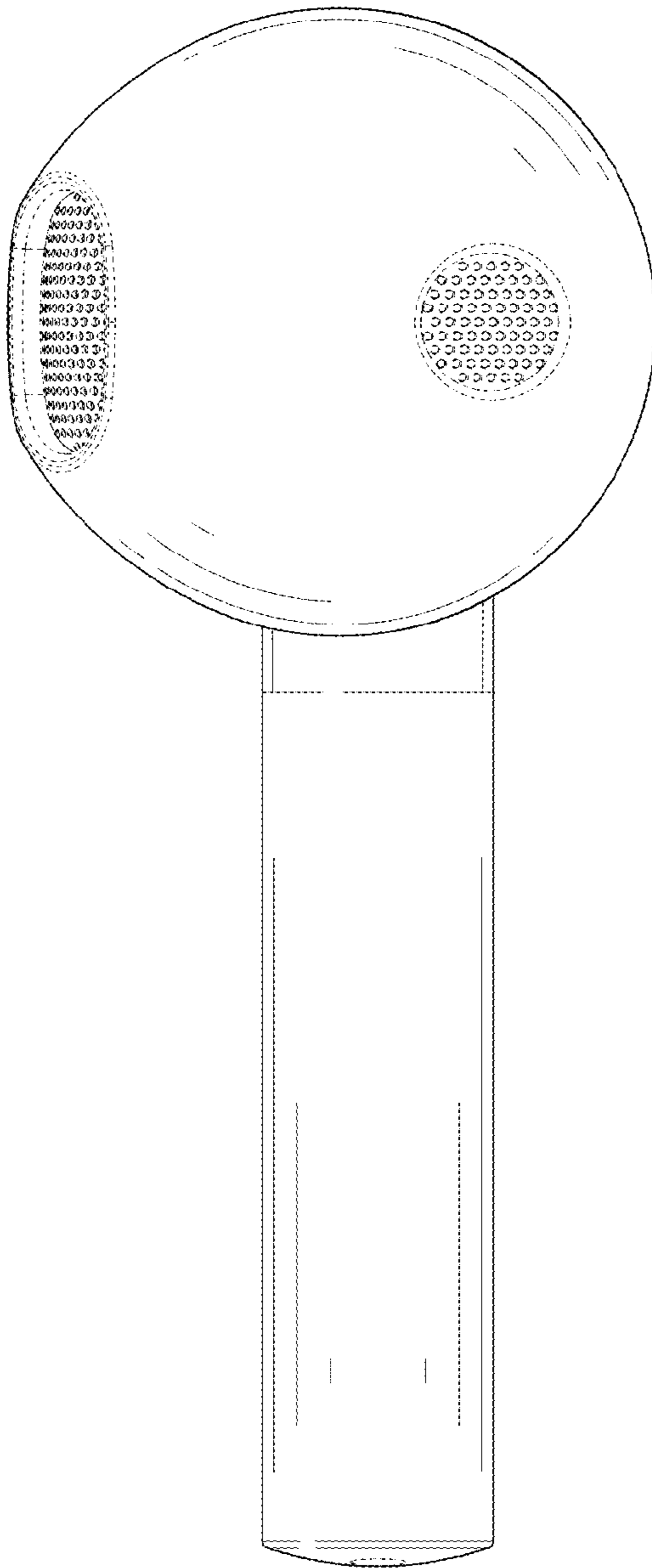


FIG. 4

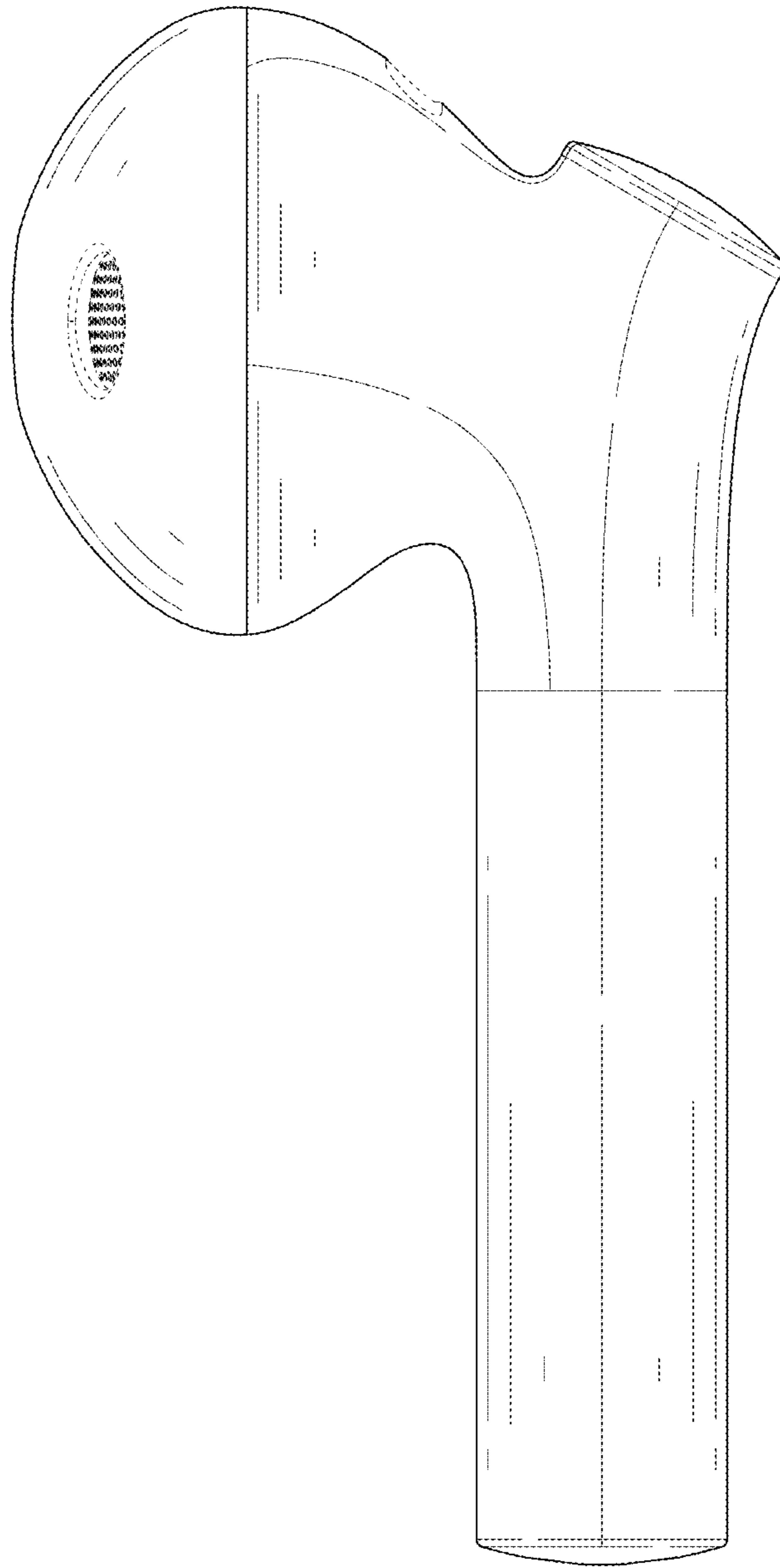


FIG. 5

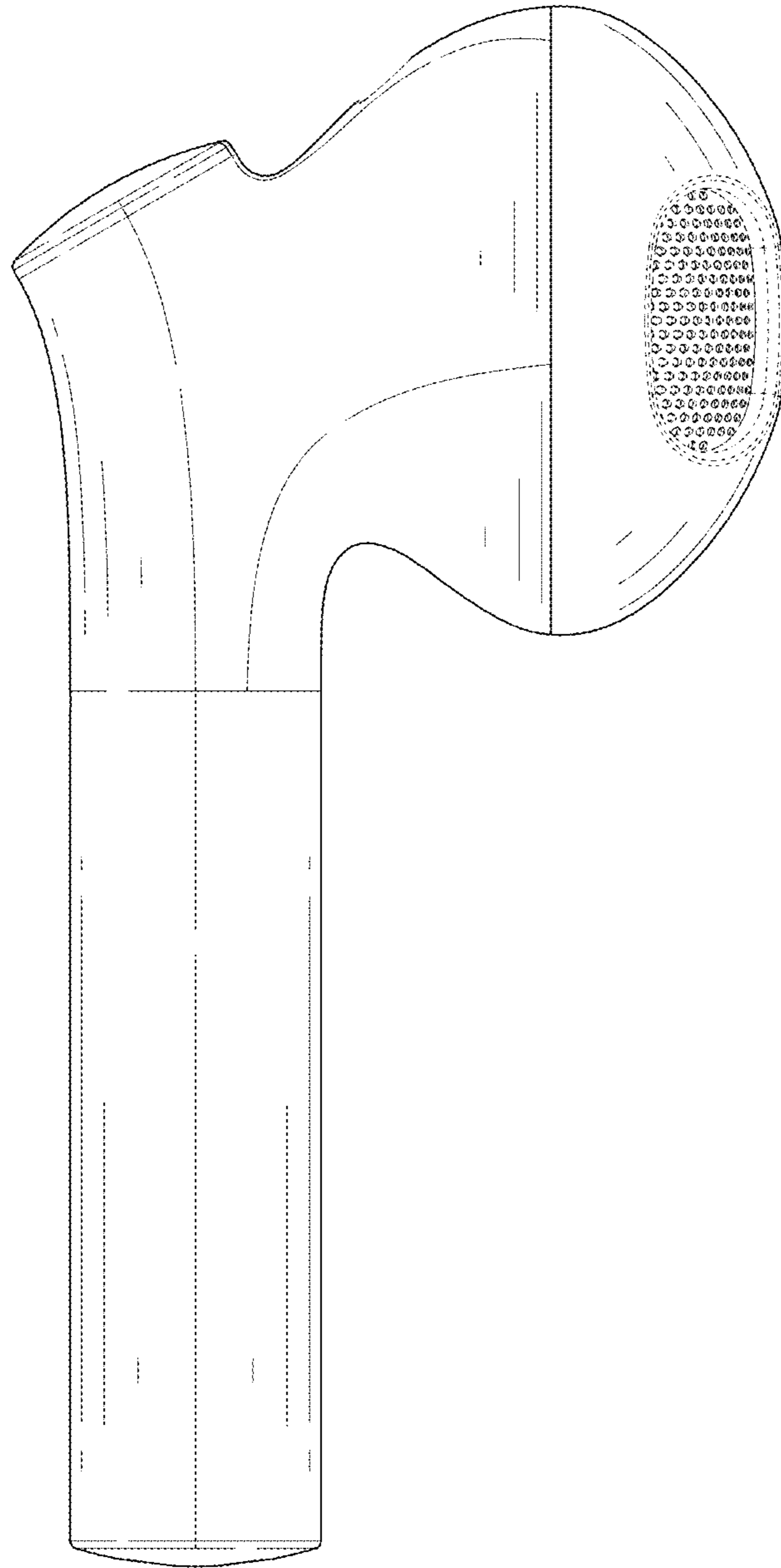


FIG. 6



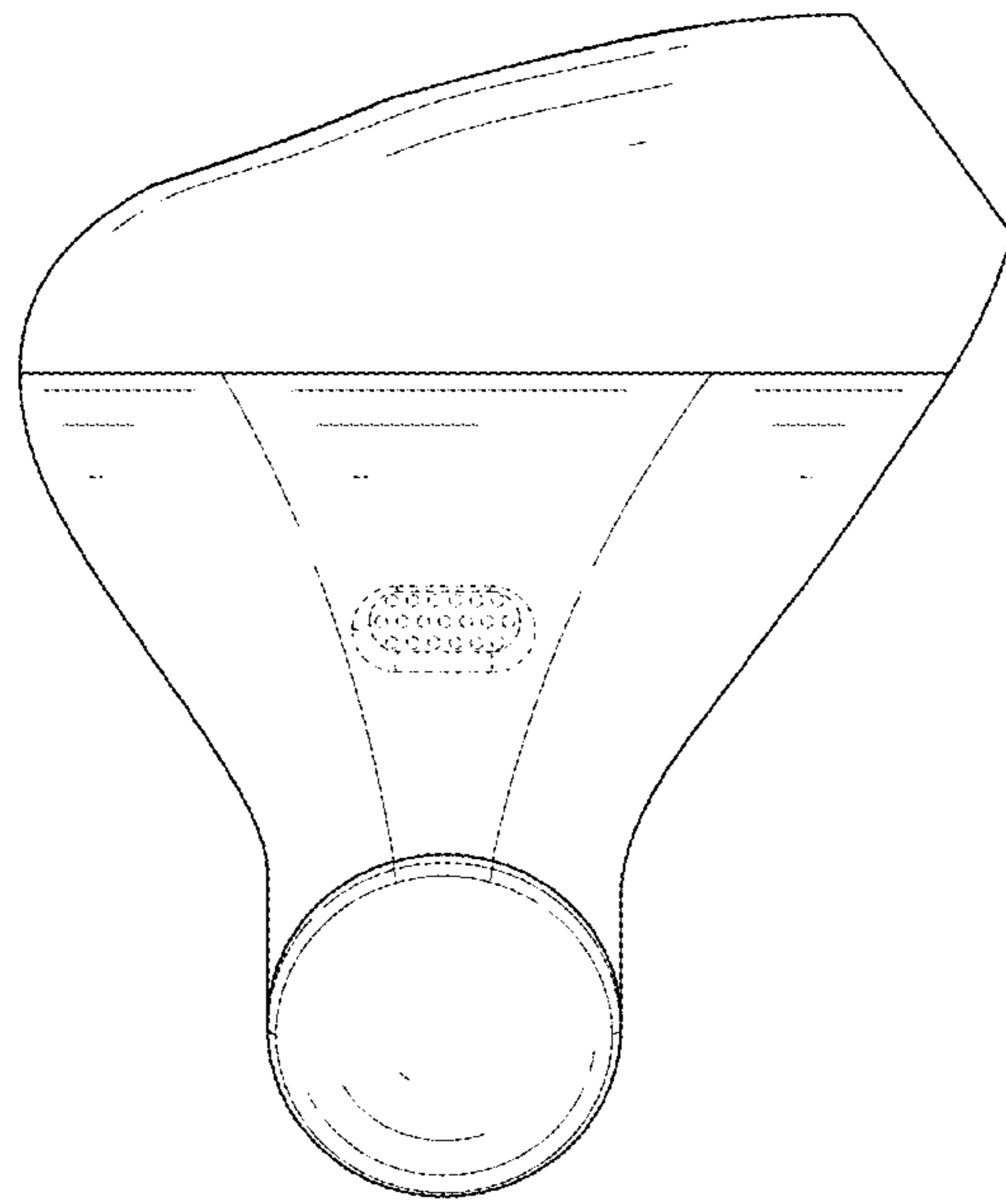


FIG. 7

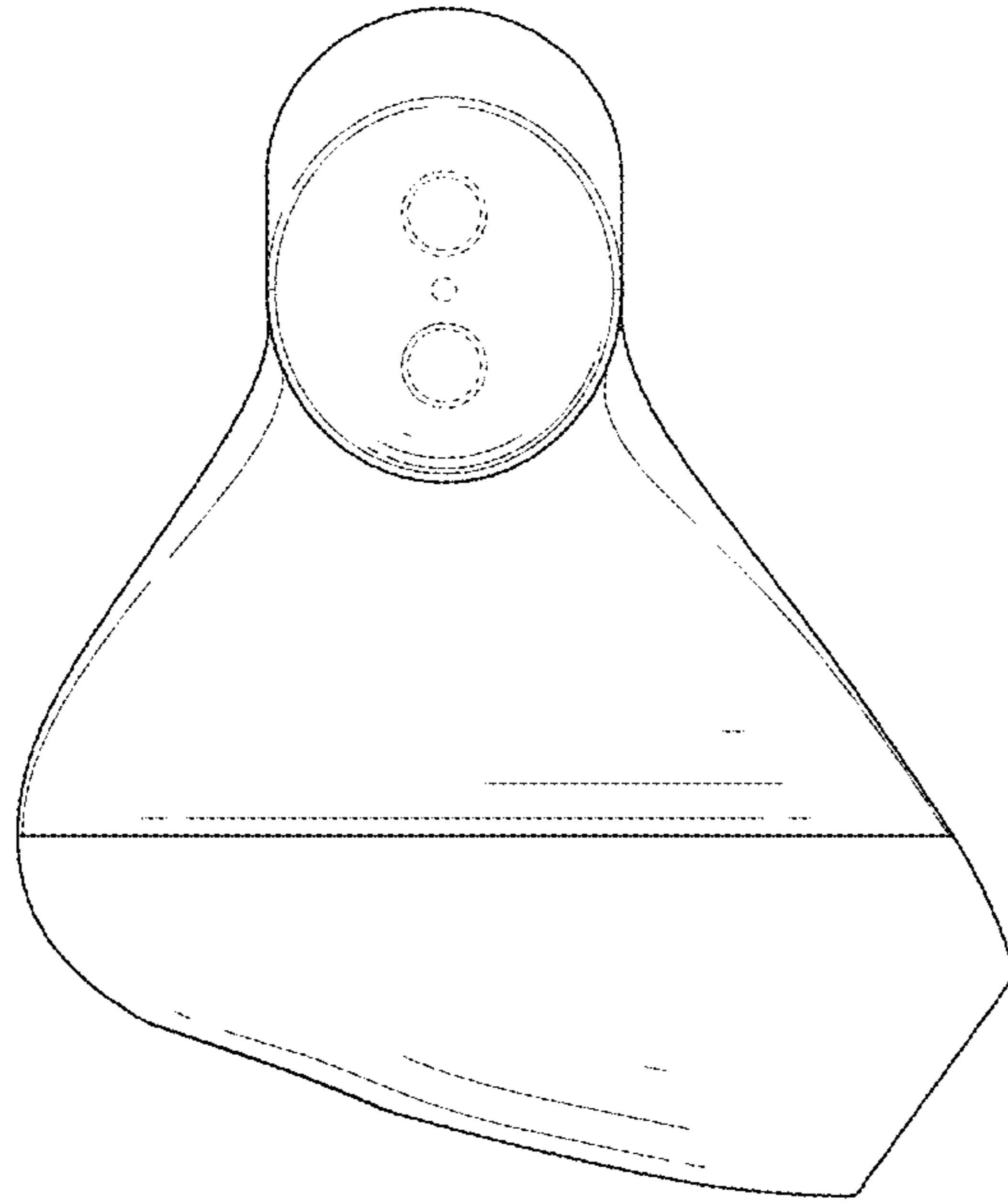


FIG. 8

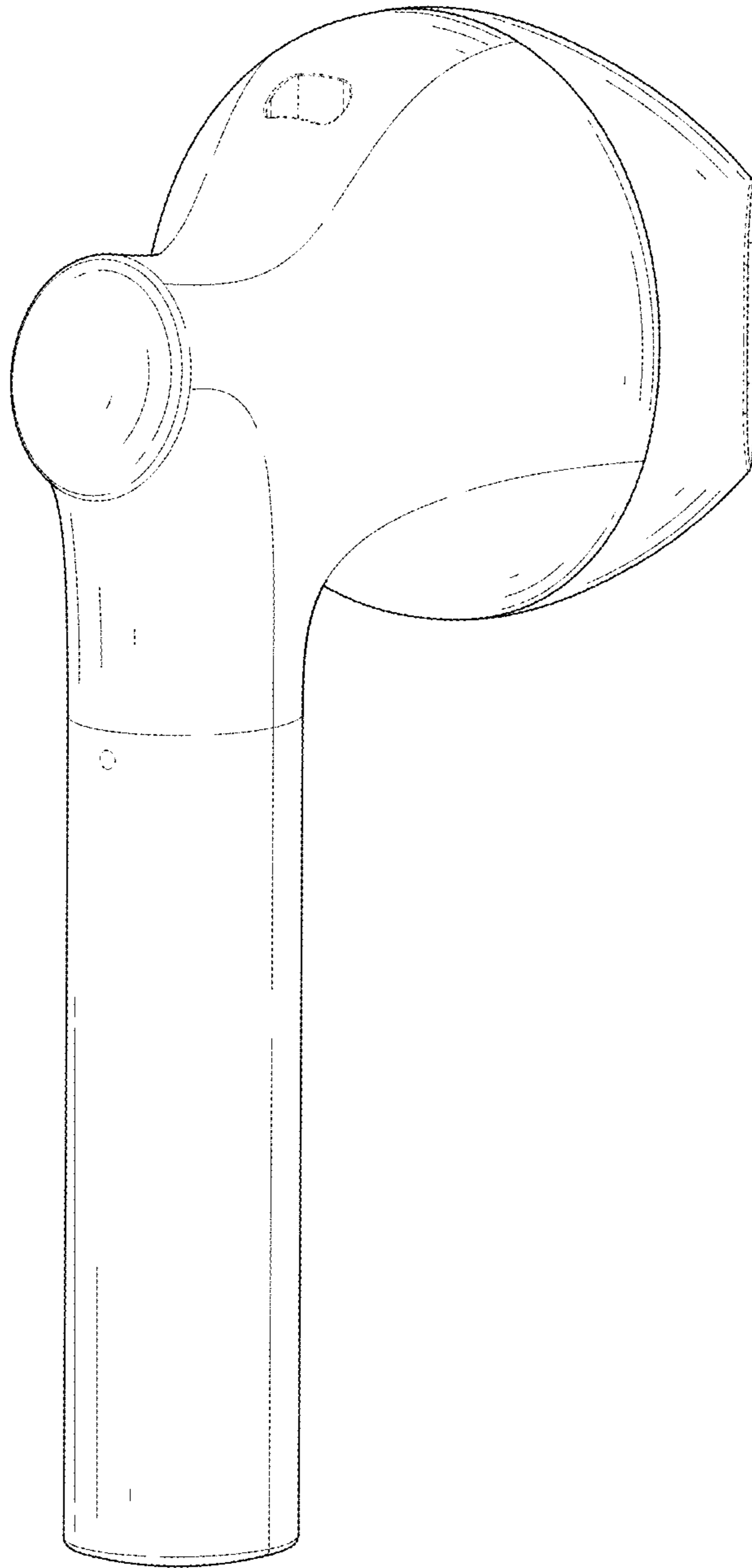


FIG. 9

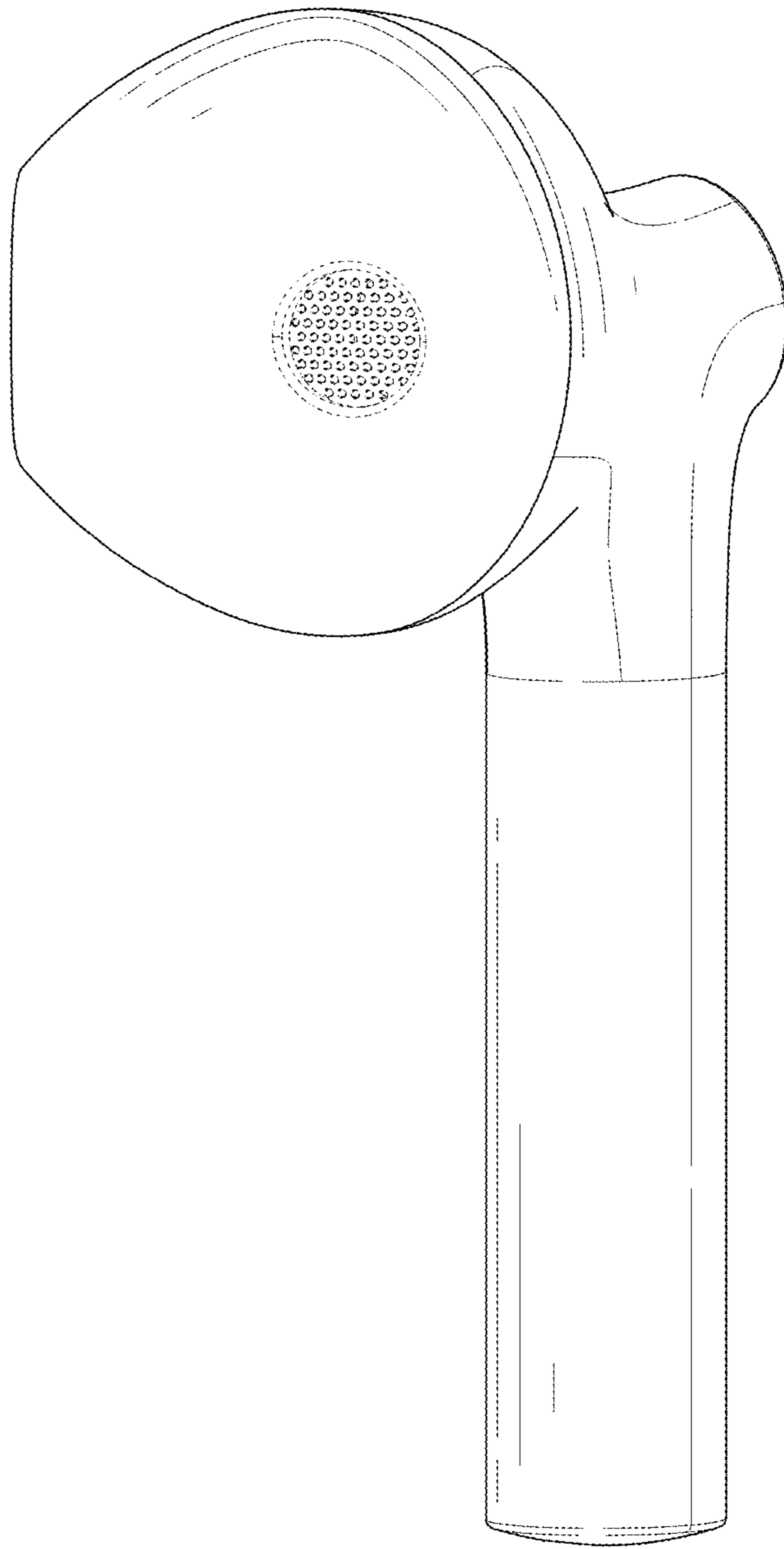


FIG. 10

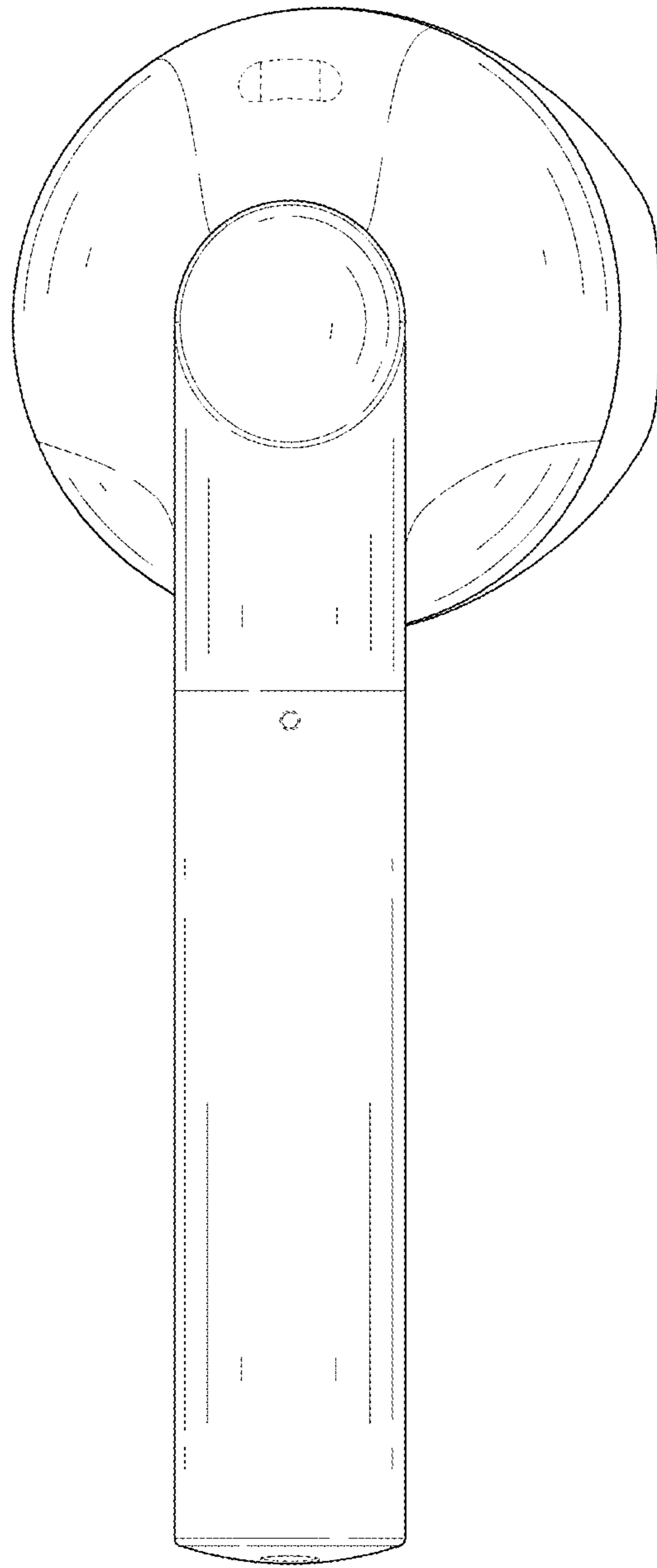


FIG. 11

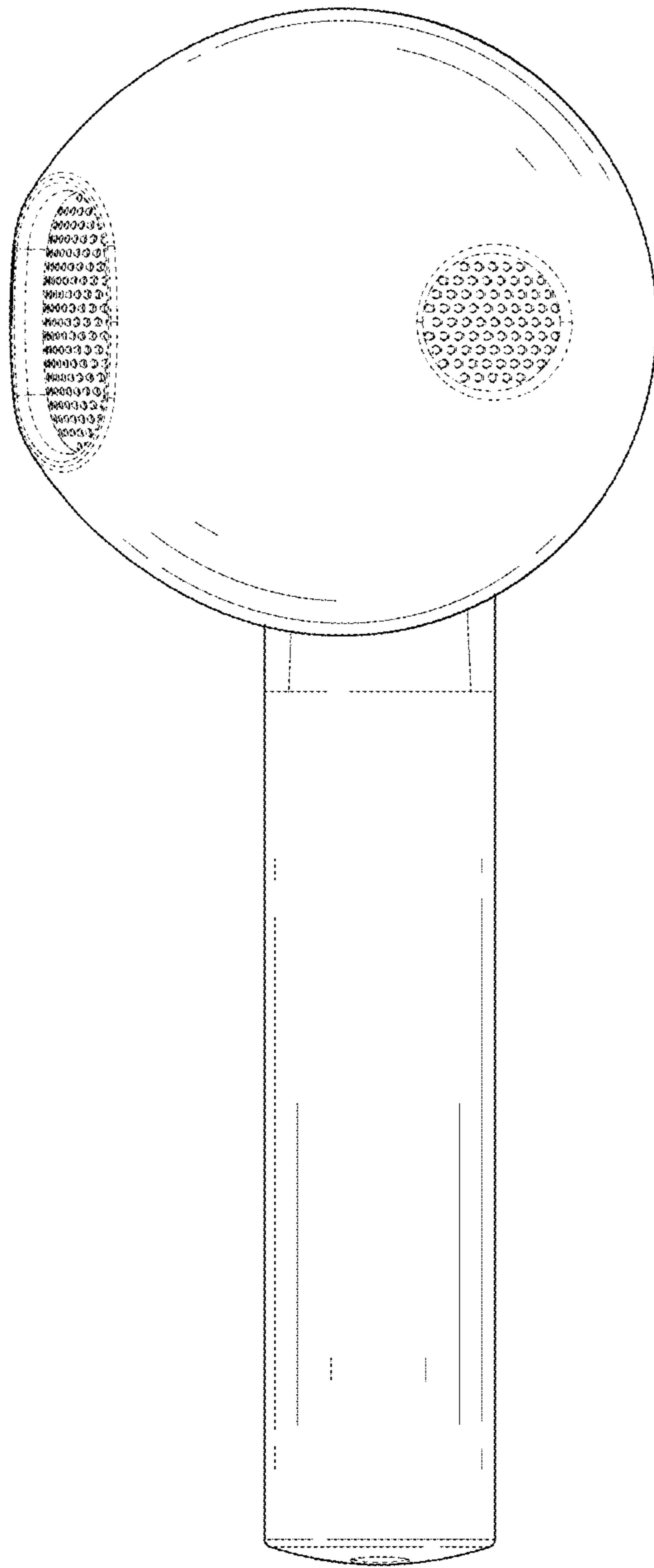


FIG. 12

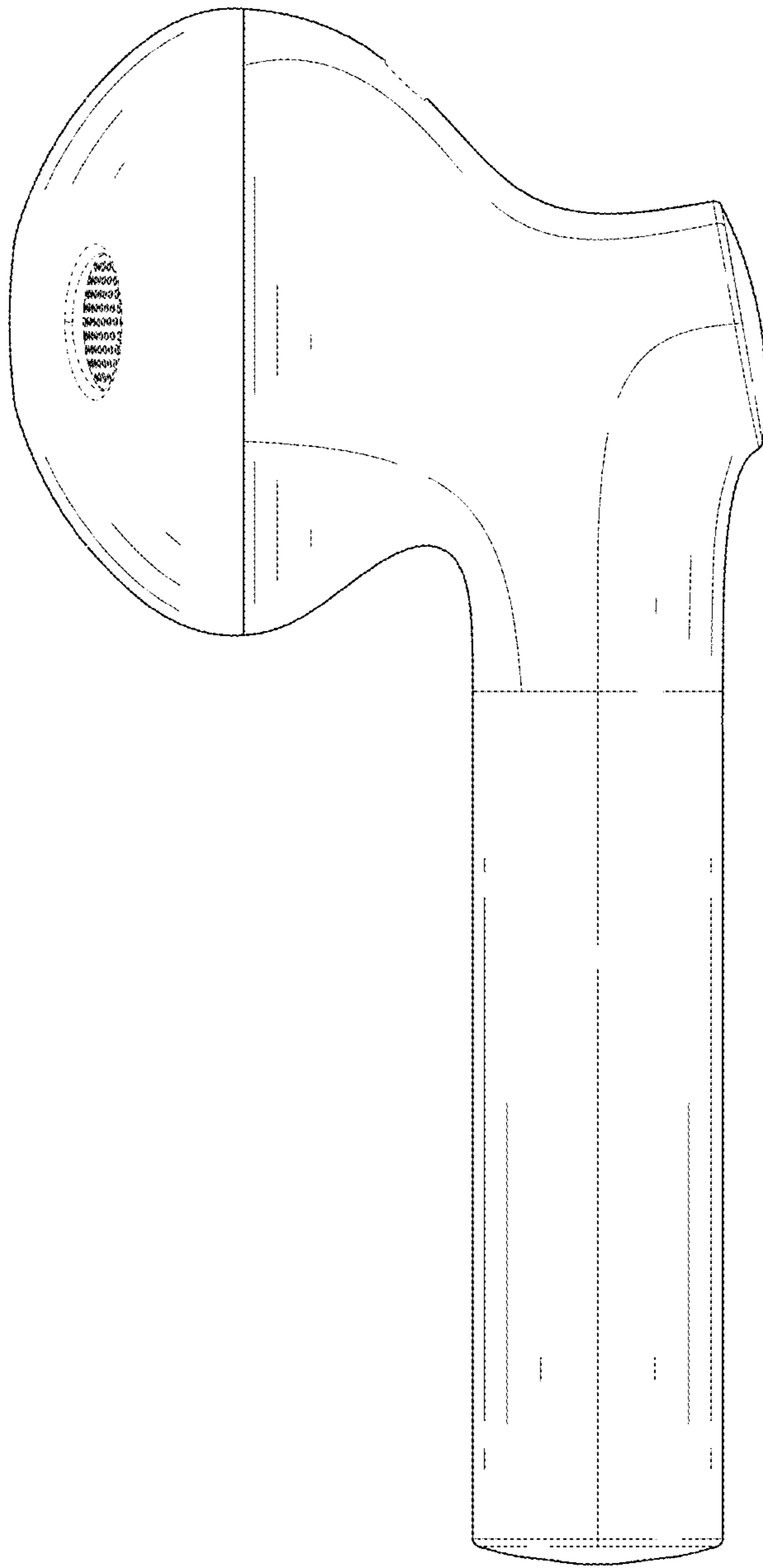


FIG. 13

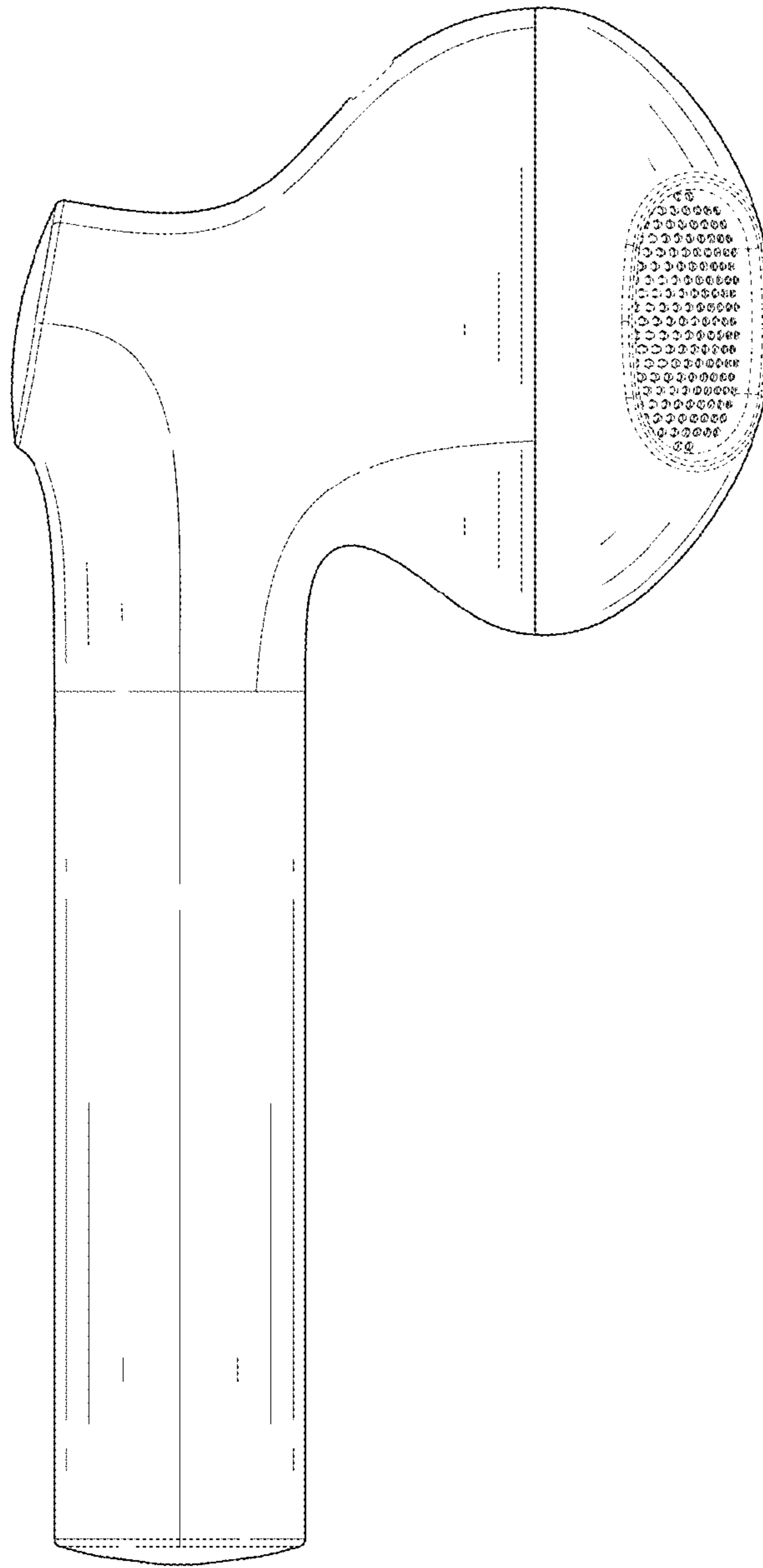


FIG. 14



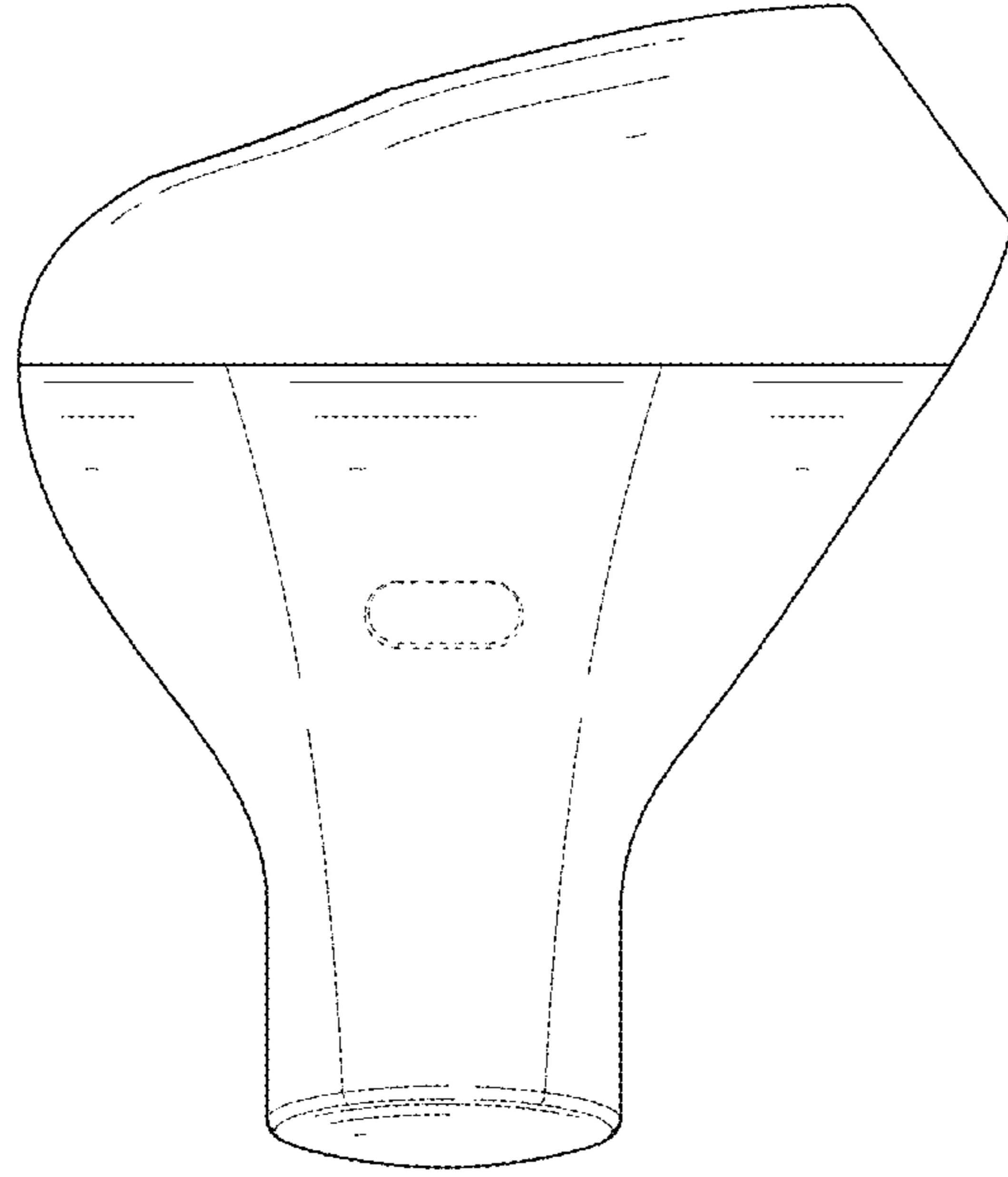


FIG. 15

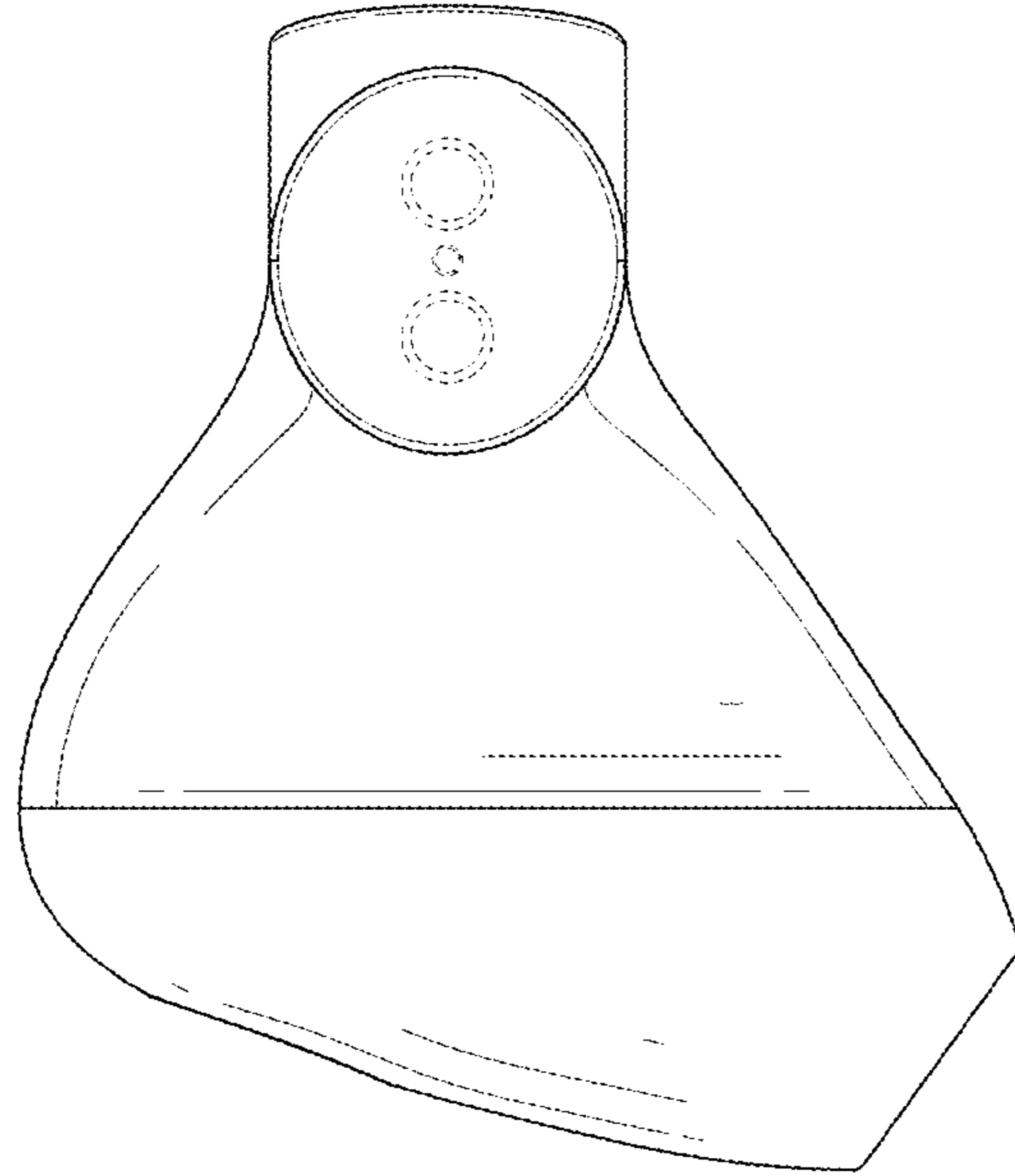


FIG. 16